Silicon N-Channel MOS FET

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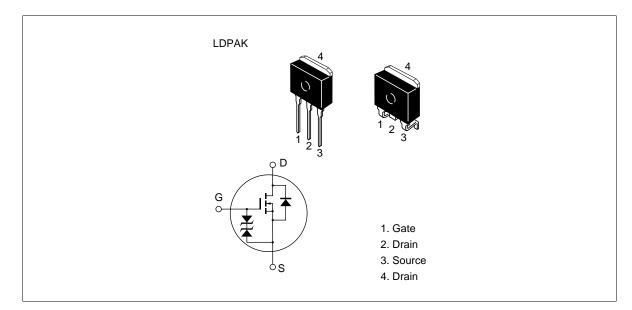
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for switching regulator and DC-DC converter

Outline





Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	600	V
Gate to source voltage	V _{GSS}	±30	V
Drain current	I _D	7	А
Drain peak current	I★1 D(pulse)	28	А
Body to drain diode reverse drain current	I _{DR}	7	А
Channel dissipation	Pch*2	75	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at $T_c = 25^{\circ}C$

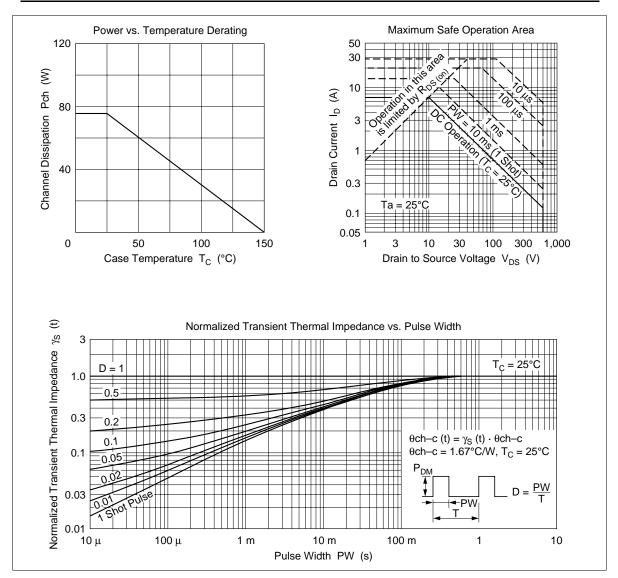
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Item	Symbol	Min	Тур	Max	Unit	Test conditions	
Drain to source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	600	_	_	V	$I_{D} = 10 \text{ mA}, V_{GS} = 0$	
Gate to source breakdown voltage	$V_{(BR)GSS}$	±30	—	—	V	$I_{g} = \pm 100 \ \mu A, \ V_{DS} = 0$	
Gate to source leak current	I _{GSS}	_		±10	μΑ	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0$	
Zero gate voltage drain current	I _{DSS}			250	μA	$V_{\rm DS} = 500 \ V, \ V_{\rm GS} = 0$	
Gate to source cutoff voltage	$V_{\text{GS(off)}}$	2.0	_	3.0	V	$I_{\rm D} = 1 \text{ mA}, V_{\rm DS} = 10 \text{ V}$	
Static Drain to source on state resistance	$R_{\text{DS(on)}}$	—	0.9	1.3	Ω	$I_{D} = 4 \text{ A}, V_{GS} = 10 \text{ V}^{*1}$	
Forward transfer admittance	yfs	4.0	6.5	_	S	$I_{\rm D} = 4$ A, $V_{\rm DS} = 10$ V * ¹	
Input capacitance	Ciss		1180		pF	$V_{\rm DS} = 10 \ V, \ V_{\rm GS} = 0,$	
Output capacitance	Coss	_	265		pF	f = 1 MHz	
Reverse transfer capacitance	Crss	_	50		pF		
Turn-on delay time	t _{d(on)}		15		ns	$I_{\rm D} = 4 \text{ A}, V_{\rm GS} = 10 \text{ V},$	
Rise time	t,	_	50		ns	$R_{L} = 7.5 \Omega$	
Turn-off delay time	t _{d(off)}	_	105		ns	—	
Fall time	t _f		45		ns		
Body to drain diode forward voltage	V_{DF}	—	0.9	—	V	$I_F = 7 \text{ A}, V_{GS} = 0$	
Body to drain diode reverse recovery time	t _{rr}	—	370	_	ns	$I_F = 7 \text{ A}, V_{GS} = 0,$ $di_F/dt = 100 \text{ A}/\mu\text{s}$	

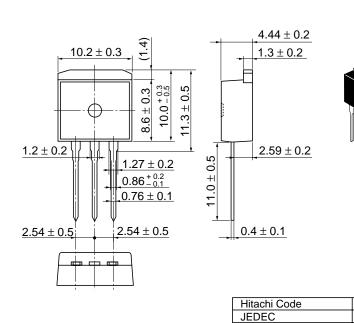
Electrical Characteristics (Ta = 25°C)

Note 1. Pulse test

See characteristic curves of 2SK1403.



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EIAJ

Unit: mm

LDPAK (L)

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EIAJ—Weight (reference value)1.4 g

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